



**SDM20U30** 

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

#### **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Capacitance
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device, (Notes 4 and 5)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)



Top View

## **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	21	V
Mean Rectifying Current (Note 2)		lo	200	mA
Peak Forward Surge Current	@ 8.3ms Half Sine	I <sub>FSM</sub>	1.0	А

### **Thermal Characteristics**

Characteristic		Value	Unit
Power Dissipation (Note 2)		150	mW
Thermal Resistance, Junction to Ambient Air (Note 2)		667	°C/W
Operating and Storage Temperature Range		-65 to +125	°C

### **Electrical Characteristics** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 3)	V <sub>(BR)R</sub>	30	_	_	V	I <sub>R</sub> = 150μA
Forward Voltage Drop	VF		_	0.35 0.50	V	$I_F = 20mA$ $I_F = 200mA$
Peak Reverse Current (Note 3)	I <sub>R</sub>	_	_	150 30	μΑ μΑ	V <sub>R</sub> = 30V V <sub>R</sub> = 10V
Total Capacitance	Ст	_	20	_	pF	V <sub>R</sub> = 0V, f = 1.0MHz

Notes: 1. No purposefully added lead.

2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

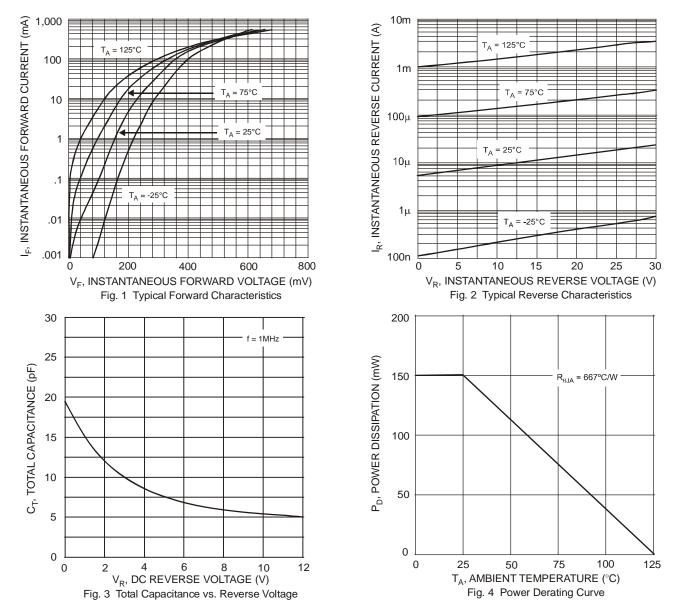
3. Short duration pulse test used to minimize self-heating effect.

4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

 Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



# SDM20U30



### Ordering Information (Notes 4 and 6)

Part Number	Case	Packaging
SDM20U30-7 (Note 7)	SOD-523	3000/Tape & Reel
SDM20U30-76K	SOD-523	6000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. 7. Dispensed in every other cavity of the tape.

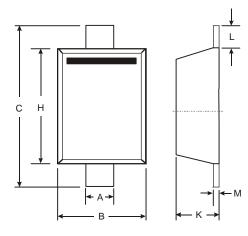
### **Marking Information**



LM = Product Type Marking Code

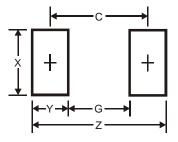


# **Package Outline Dimensions**



SOD-523				
Dim	Min	Max		
Α	0.25	0.35		
В	0.70	0.90		
C	1.50	1.70		
Н	1.10	1.30		
K	0.55	0.70		
L	0.10	0.30		
Μ	0.10	0.20		
All Dimensions in mm				

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.3
G	1.1
Х	0.8
Y	0.6
С	1.7

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